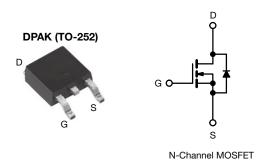
COMPLIANT HALOGEN

FREE



E Series Power MOSFET

PRODUCT SUMMARY		
V _{DS} (V) at T _J max.	550)
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 \text{ V}$	0.380
Q _g max. (nC)	50	
Q _{gs} (nC)	6	
Q _{gd} (nC)	10	
Configuration	Single	



FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- · Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION		
Package	DPAK (TO-252)	
Lead (Pb)-free and halogen-free	SiHD12N50E-GE3	
Lead (Pb)-free and halogen-free	SiHD12N50E-T1-GE3	

ABSOLUTE MAXIMUM RATINGS (To	_C = 25 °C, unl	ess otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	500	V
Gate-source voltage			V_{GS}	± 30	v
Continuous drain august /T 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$,	10.5	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	6.6	Α
Pulsed drain current ^a		I _{DM}	21		
Linear derating factor			0.91	W/°C	
Single pulse avalanche energy b		E _{AS}	103	mJ	
Maximum power dissipation		P_{D}	114	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $V_{DS} = 0 \text{ V to } 80 \text{ % } V_{DS}$		dV/dt	70	V/ns	
Reverse diode dV/dt ^d			27	V/ns	
Soldering recommendations (peak temperature) c for 10 s			300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_a = 25 Ω , I_{AS} = 2.7 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μs , starting $T_J = 25$ °C

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction to ambient	R _{thJA}	-	62	°C/W
Maximum junction to case (drain)	R_{thJC}	-	1.1	C/ VV



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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		_				L	
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.60	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
7		V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 400 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A	-	0.330	0.380	Ω
Forward transconductance	9fs	V _{DS}	s = 30 V, I _D = 6 A	-	3.1	-	S
Dynamic				•	•		
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	886	-	
Output capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$	-	52	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	6	-	
Effective output capacitance, energy related ^a	$C_{o(er)}$			-	45	-	pF
Effective output capacitance, time related ^b	$C_{o(tr)}$	$V_{DS} = 0.0$	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		131	-	
Total gate charge	Qg			-	25	50	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 6 A, V_{DS} = 400 V$	-	6	-	nC
Gate-drain charge	Q _{gd}			-	10	-	
Turn-on delay time	t _{d(on)}			-	13	26	
Rise time	t _r	Von	V _{DD} = 400 V, I _D = 6 A,		16	32	
Turn-off delay time	t _{d(off)}		= 10 V, $R_q = 9.1 \Omega$	-	29	58	ns
Fall time	t _f		•	-	12	24	
Gate input resistance	R _g	f = 1	MHz, open drain	-	0.92	-	Ω
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10.5	
Pulsed diode forward current	I _{SM}			-	-	21	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 7.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C, } I_F = I_S = 6 \text{ A,}$ $dI/dt = 100 \text{ A/µs, } V_R = 25 \text{ V}$		-	244	-	ns
Reverse recovery charge	Q _{rr}			-	2.5	-	μC
Reverse recovery current	I _{RRM}				19	_	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

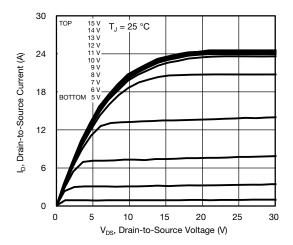


Fig. 1 - Typical Output Characteristics

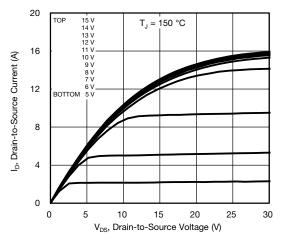


Fig. 2 - Typical Output Characteristics

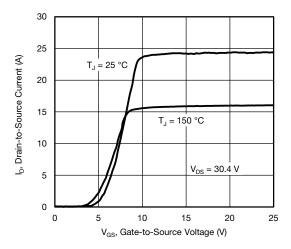


Fig. 3 - Typical Transfer Characteristics

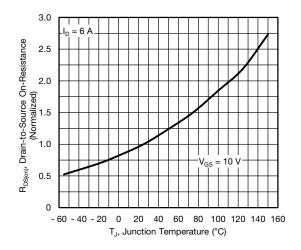


Fig. 4 - Normalized On-Resistance vs. Temperature

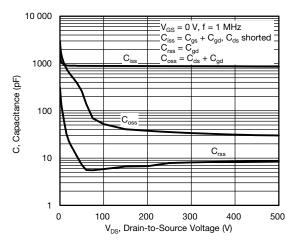


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

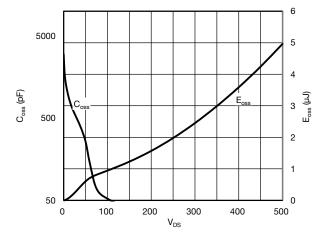


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



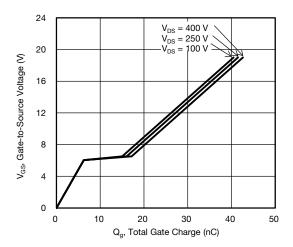


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

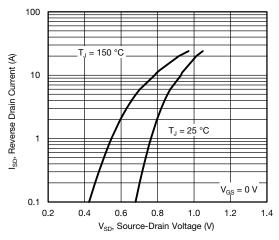


Fig. 8 - Typical Source-Drain Diode Forward Voltage

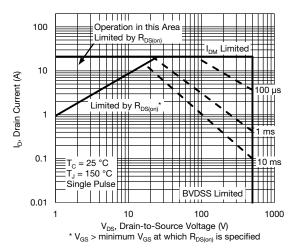


Fig. 9 - Maximum Safe Operating Area

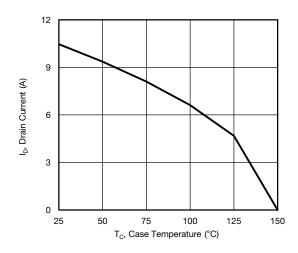


Fig. 10 - Maximum Drain Current vs. Case Temperature

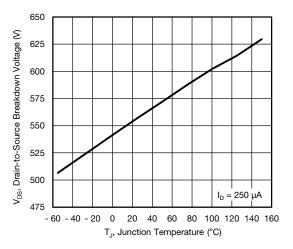


Fig. 11 - Temperature vs. Drain-to-Source Voltage



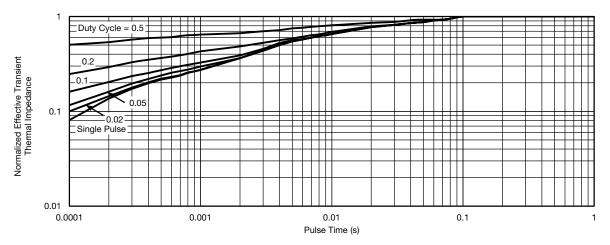


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

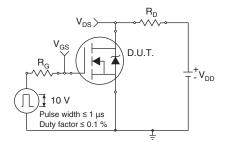


Fig. 13 - Switching Time Test Circuit

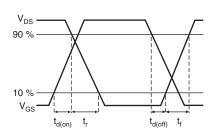


Fig. 14 - Switching Time Waveforms

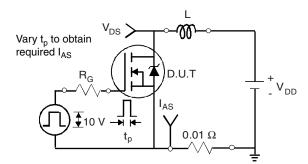


Fig. 15 - Unclamped Inductive Test Circuit

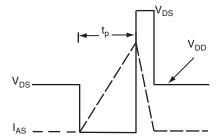


Fig. 16 - Unclamped Inductive Waveforms

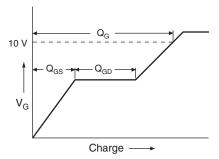


Fig. 17 - Basic Gate Charge Waveform

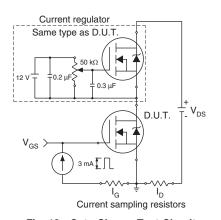
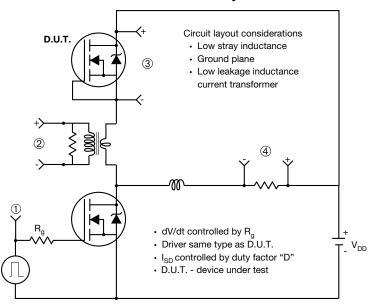


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



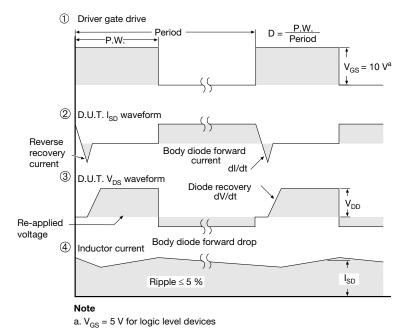


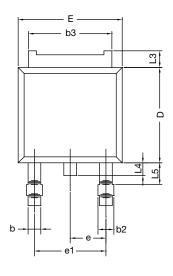
Fig. 19 - For N-Channel

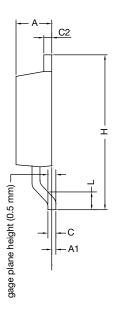
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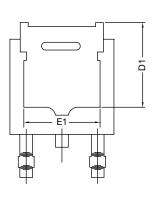


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







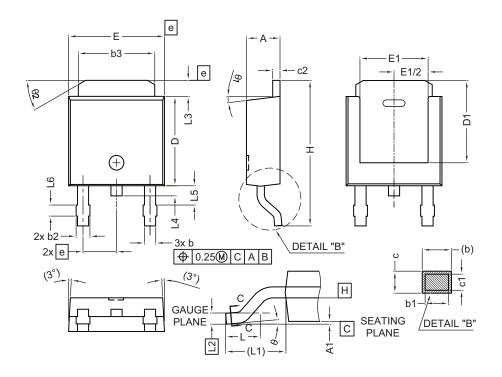
	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	=	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	=	
Е	6.35	6.73	
E1	4.32 -		
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- · Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022

DWG: 5347



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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